SHENGZHEN MAYA
ELECTRONICS CREATION CO.,
LIMITED.

FCC Confidentiality Request

Number: **CF303**
Version: **V05**
Date: 21-05-2012

(Permanent or also called long term confidentiality is the normal method to keep certain docuements confidential, and may apply to schematics, block diagrams, operational description and bill of materials.)

To: **Federal Communications Commission**
Equipment Authorization Branch
7435 Oakland Mills Road
Columbia, MD 21046

Pursuant to 47 CFR Section 0.459(a) & (b), we,

(the applicant / grantee)

Company name	SHENGZHEN MAYA ELECTRONICS CREATION CO., LIMITED
Address	5F, M-10,Centre of Hi-Tech Ind. Dist.
City	ShenZhen
Country	China

request for this certification filing under:

	Grantee Code	*Product Number*
FCC ID:	SFQ	MYA006

to maintain **permanent confidentiality** for the following documents submitted within this application:

(please cross what is applicable, or add other documents, provide the file name and description)

	Exhibit	*File Name*	*Description*
1	Operational Description	operational description	explaining the functioning of the block diagram
2	Block Diagrams	Block diagram	showing the systematic building blocks of the EUT
3	Schematics Diagrams	Schematic	showing components, their values and interconnection
			List of components used on the PCB's of the EUT

Above materials crossed contain secrets, proprietary and technical information, which would customarily be guarded from competitors under 47 CFR, section 0.457(d)(2). Disclosure or publication or any portion of this company confidential material to other parties could cause substantial competitive harm and provide unjustified benefits for competitors. We understand that pursuant to 47 CFR section 0.457(d)(1)(ii) disclosure of the applicant and all accompanying documentation will not be made before the date of the grant. The documents indicated as confidential above, are not publicly available elsewhere.

Attestation:

City and Country:	**Date:**	**Name:** (this must be a person)	**Function:**	**Signature:** (or official company stamp)
Shenzhen	3-17-2013	Yujun Hu	R&D Director	